



## T12xxH Series 12A TRIACs

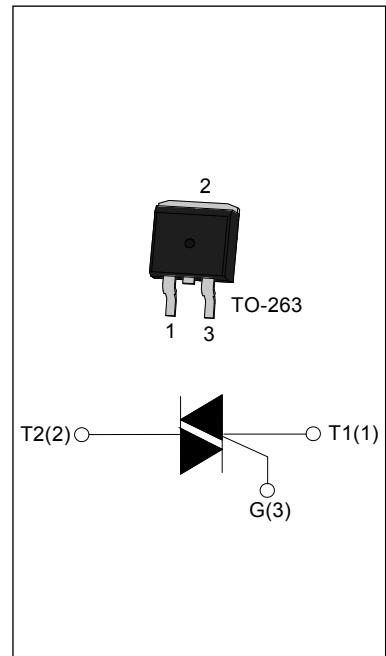
Rev.8.0

## DESCRIPTION:

T12xxH series triacs of high junction temperature with high dv/dt rate with strong resistance to electromagnetic interference provide high ability to withstand the shock loading of large current. They are especially recommended for use on inductive load and high environment temperature condition. Package TO-263 is RoHS compliant. (2011/65/EU)

## MAIN FEATURES

| Symbol                              | Value   | Unit |
|-------------------------------------|---------|------|
| I <sub>T(RMS)</sub>                 | 12      | A    |
| V <sub>DRM</sub> / V <sub>RRM</sub> | 600/800 | V    |
| T <sub>jmax</sub>                   | 150     | °C   |



## ABSOLUTE MAXIMUM RATINGS

| Parameter  | Symbol              | Value                  | Unit             |
|--|---------------------|------------------------|------------------|
| Storage junction temperature range   | T <sub>stg</sub>    | -40-150                | °C               |
| Operating junction temperature range   | T <sub>j</sub>      | -40-150                | °C               |
| Repetitive peak off-state voltage(T <sub>j</sub> =25°C)                        | V <sub>DRM</sub>    | 600/800                | V                |
| Repetitive peak reverse voltage(T <sub>j</sub> =25°C)                          | V <sub>RRM</sub>    | 600/800                | V                |
| Non repetitive surge peak Off-state voltage                                    | V <sub>DSM</sub>    | V <sub>DRM</sub> + 100 | V                |
| Non repetitive peak reverse voltage  | V <sub>RSM</sub>    | V <sub>RRM</sub> + 100 | V                |
| RMS on-state current<br>TO-263 (T <sub>C</sub> =125°C)                         | I <sub>T(RMS)</sub> | 12                     | A                |
| Non repetitive surge peak on-state current<br>(full cycle, F=50Hz)             | I <sub>TSM</sub>    | 120                    | A                |
| I <sup>2</sup> t value for fusing (tp=10ms)                                    | I <sup>2</sup> t    | 78                     | A <sup>2</sup> s |
| Critical rate of rise of on-state current (I <sub>G</sub> =2×I <sub>GT</sub> ) | dI/dt               | 50                     | A/μs             |
| Peak gate current  | I <sub>GM</sub>     | 4                      | A                |
| Average gate power dissipation   | P <sub>G(AV)</sub>  | 1                      | W                |
| Peak gate power  | P <sub>GM</sub>     | 5                      | W                |

ELECTRICAL CHARACTERISTICS ( $T_j=25^\circ\text{C}$  unless otherwise specified)

| Symbol   | Test Condition  | Quadrant    |     | Value  |        |        |        | Unit       |
|----------|---|-------------|-----|--------|--------|--------|--------|------------|
|          |   |             |     | T1210H | T1220H | T1235H | T1250H |            |
| $I_{GT}$ | $V_D=12\text{V}$ $R_L=33\Omega$                                   | I - II -III | MAX | 10     | 20     | 35     | 50     | mA         |
| $V_{GT}$ |   | I - II -III | MAX | 1.3    |        |        |        | V          |
| $V_{GD}$ | $V_D=V_{DRM}$ $T_j=150^\circ\text{C}$<br>$R_L=3.3\text{K}\Omega$  | I - II -III | MIN | 0.2    |        |        |        | V          |
| $I_L$    | $I_G=1.2I_{GT}$   | I -III      | MAX | 20     | 40     | 50     | 70     | mA         |
|          |   | II          |     | 35     | 55     | 70     | 100    |            |
| $I_H$    | $I_T=100\text{mA}$  |             | MAX | 20     | 30     | 45     | 60     | mA         |
| $dV/dt$  | $V_D=2/3V_{DRM}$ $R_{GK}=1\text{K}\Omega$ $T_j=150^\circ\text{C}$ |             | MIN | 200    | 500    | 1000   | 1500   | V/ $\mu$ s |

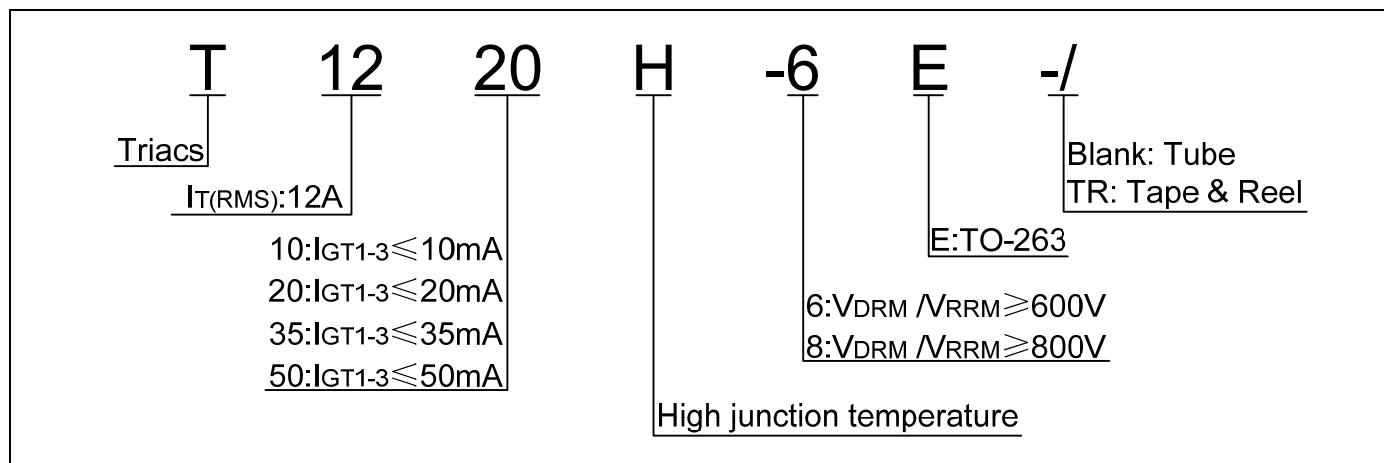
## STATIC CHARACTERISTICS

| Symbol    | Parameter           |                      | Value(MAX)              | Unit |
|-----------|---------------------|----------------------|-------------------------|------|
| $V_{TM}$  | $I_{TM}=17\text{A}$ | $t_p=380\mu\text{s}$ | $T_j=25^\circ\text{C}$  | 1.4  |
| $I_{DRM}$ | $V_D=V_{DRM}$       | $V_R=V_{RRM}$        | $T_j=25^\circ\text{C}$  | 5    |
| $I_{RRM}$ |                     |                      | $T_j=150^\circ\text{C}$ | 2    |

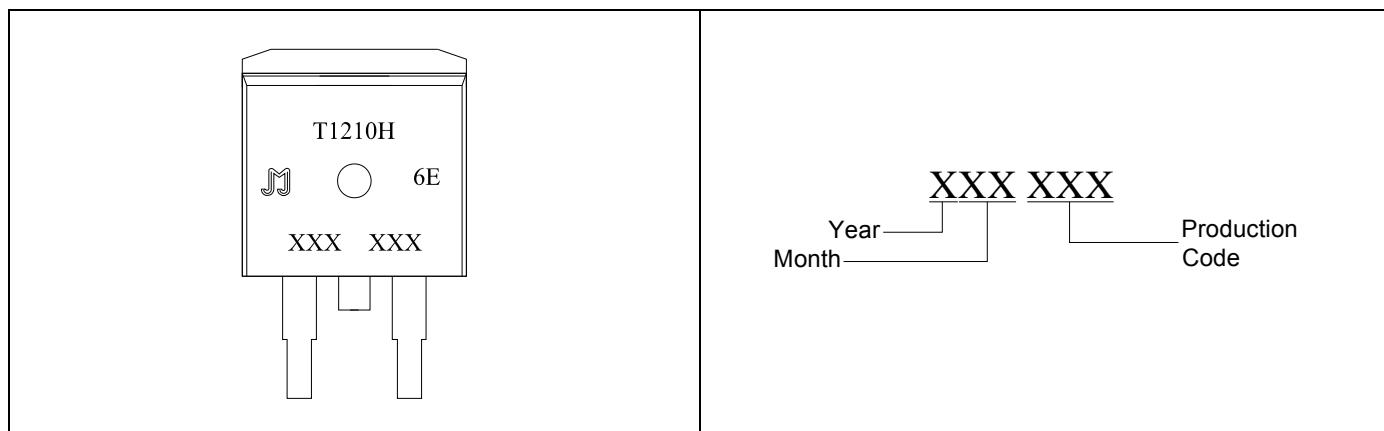
## THERMAL RESISTANCES

| Symbol        | Parameter                     |        | Value | Unit |
|---------------|-------------------------------|--------|-------|------|
| $R_{th(j-c)}$ | $\text{junction to case(AC)}$ | TO-263 | 0.97  | °C/W |
| $R_{th(j-a)}$ | $\text{junction to ambient}$  |        | 45    |      |

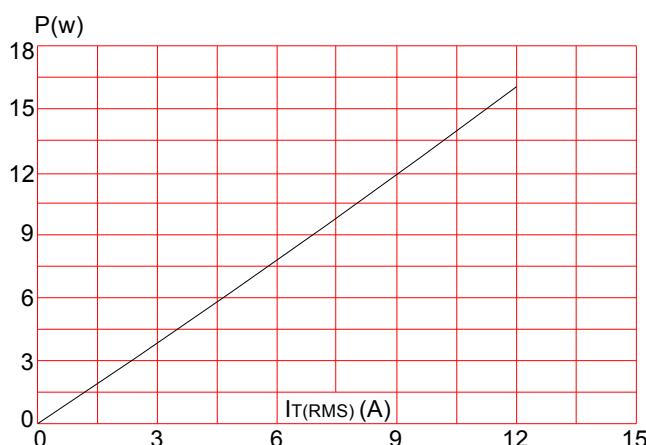
## **ORDERING INFORMATION**



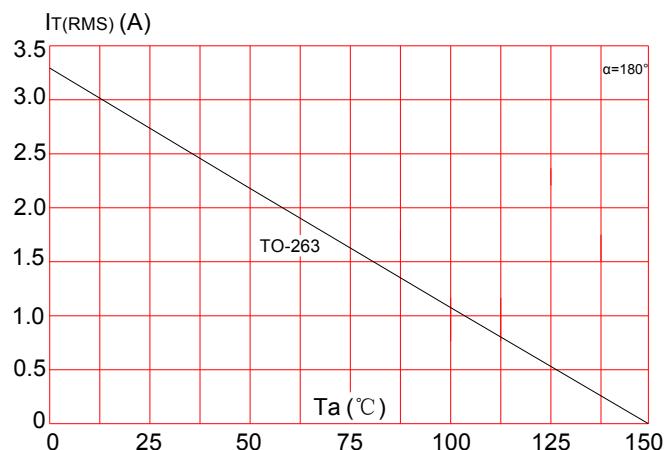
## **MARKING**



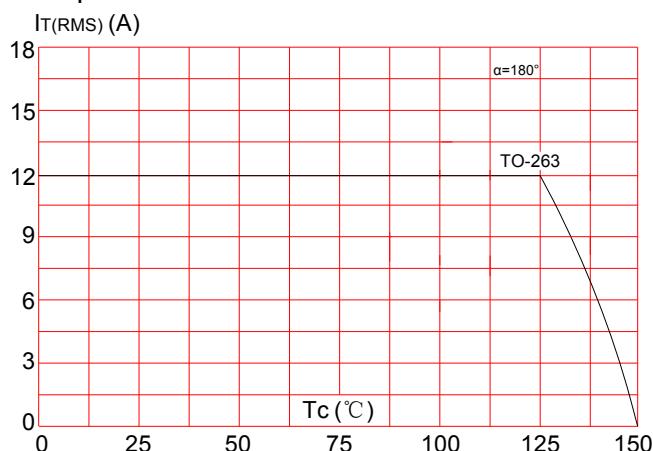
**FIG.1:** Maximum power dissipation versus RMS on-state current



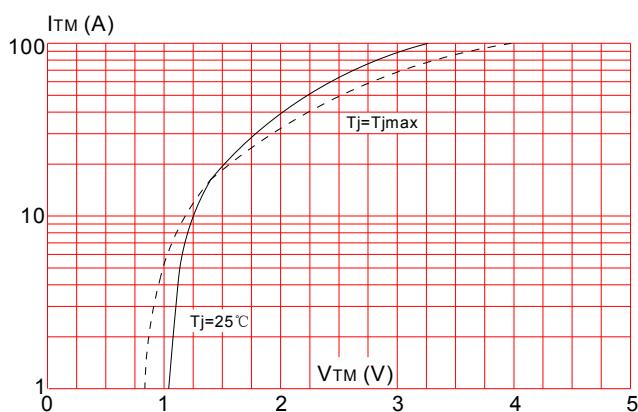
**FIG.2:** RMS on-state current versus ambient temperature (printed circuit board FR4, copper thickness:35 $\mu$ m)(full cycle)



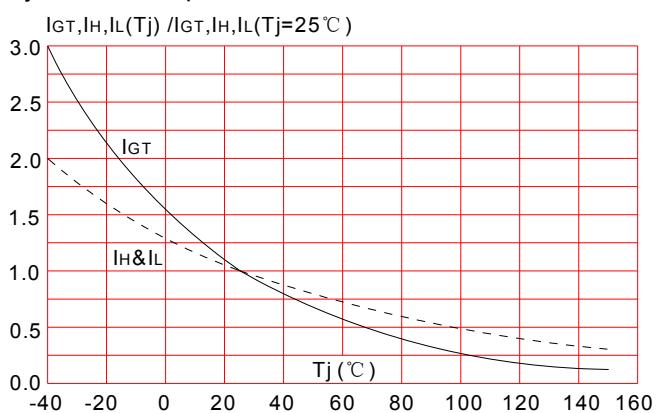
**FIG.3:** RMS on-state current versus case temperature



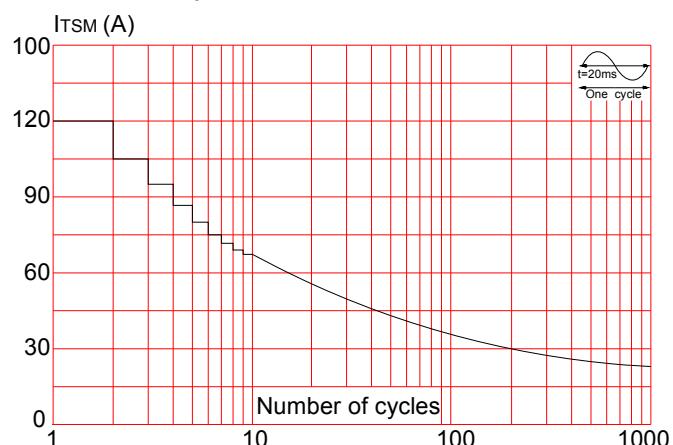
**FIG.5:** On-state characteristics (maximum values)



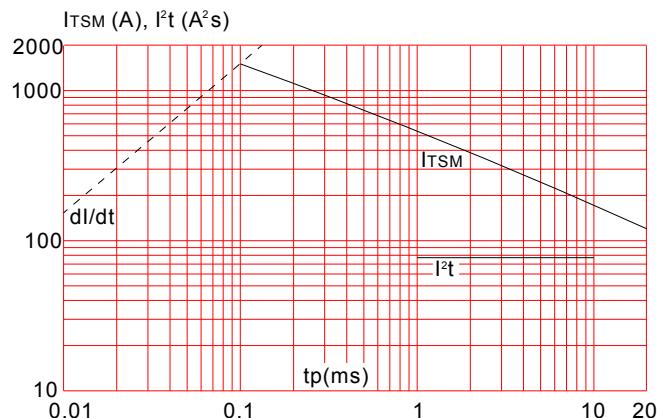
**FIG.7:** Relative variations of gate trigger current, holding current and latching current versus junction temperature



**FIG.4:** Surge peak on-state current versus number of cycles

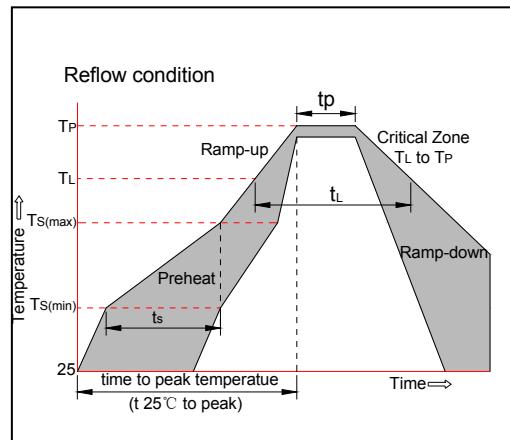


**FIG.6:** Non-repetitive surge peak on-state current for a sinusoidal pulse with width tp<20ms, and corresponding value of I<sup>2</sup>t (dI/dt < 50A/μs)



## SOLDERING PARAMETERS

|   |                                   |   |
|---|-----------------------------------|---|
| Reflow Condition  |                                   | Pb-Free assembly<br>(see figure at right) |
| Pre Heat  | -Temperature Min ( $T_{s(min)}$ ) | +150°C                                    |
|   | -Temperature Max( $T_{s(max)}$ )  | +200°C                                    |
|   | -Time (Min to Max) ( $t_s$ )      | 60-180 secs.                              |
| Average ramp up rate<br>(Liquidus Temp ( $T_L$ ) to peak) |                                   | 3°C/sec. Max                              |
| $T_{s(max)}$ to $T_L$ - Ramp-up Rate                      |                                   | 3°C/sec. Max                              |
| Reflow  | -Temperature( $T_L$ )(Liquidus)   | +217°C                                    |
|   | -Temperature( $t_L$ )             | 60-150 secs.                              |
| Peak Temp ( $T_p$ )                                       |                                   | +260(+0/-5)°C                             |
| Time within 5°C of actual Peak Temp ( $t_p$ )             |                                   | 20-40secs.                                |
| Ramp-down Rate  |                                   | 6°C/sec. Max                              |
| Time 25°C to Peak Temp ( $T_p$ )                          |                                   | 8 min. Max                                |
| Do not exceed   |                                   | +260°C                                    |



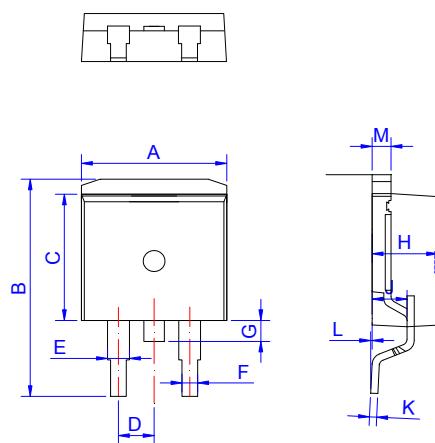
## ORDERING INFORMATION

| Order code   | Voltage<br>$V_{DRM}/V_{RRM}$ (V) | IGT(mA) | Package | Base qty.<br>(pcs) | Delivery mode |
|--------------|----------------------------------|---------|---------|--------------------|---------------|
| T1210H-6(8)E | 600/800                          | 10      | TO-263  | 50                 | Tube          |
| T1220H-6(8)E |                                  | 20      |         |                    |               |
| T1235H-6(8)E |                                  | 35      |         | 800                |               |
| T1250H-6(8)E |                                  | 50      |         |                    | Tape & Reel   |

**Document Revision History**

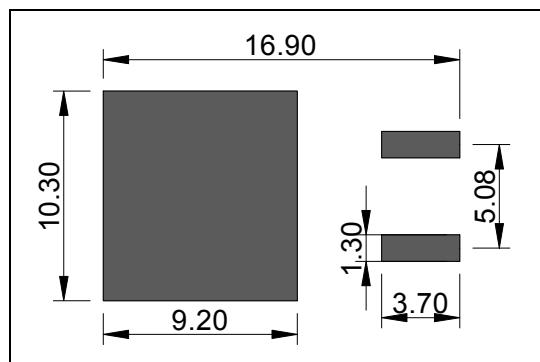
| Date         | Revision | Changes  |
|--------------|----------|--|
| Apr 29, 2019 | 7        | Last update  |
| Feb 12, 2022 | 8        | Add Fig.3 RMS on-state current versus case temperature |

## PACKAGE MECHANICAL DATA

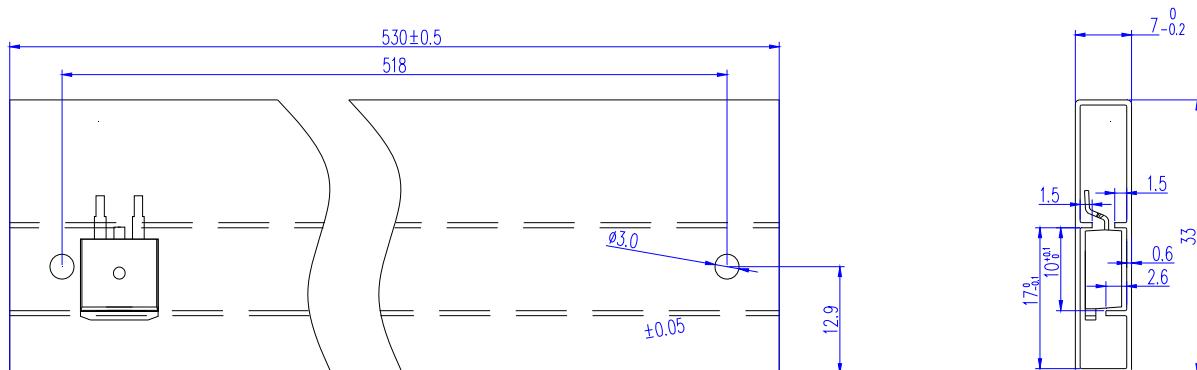


| Ref. | Dimensions  |      |       |        |       |       |
|------|-------------|------|-------|--------|-------|-------|
|      | Millimeters |      |       | Inches |       |       |
|      | Min.        | Typ. | Max.  | Min.   | Typ.  | Max.  |
| A    | 9.90        |      | 10.20 | 0.390  |       | 0.402 |
| B    | 14.70       |      | 15.80 | 0.579  |       | 0.622 |
| C    | 9.4         |      | 9.6   | 0.37   |       | 0.378 |
| D    |             | 2.54 |       |        | 0.100 |       |
| E    | 1.20        |      | 1.40  | 0.047  |       | 0.055 |
| F    | 0.75        |      | 0.85  | 0.029  |       | 0.033 |
| G    |             |      | 1.75  |        |       | 0.069 |
| H    | 4.40        |      | 4.70  | 0.173  |       | 0.185 |
| J    | 2.30        |      | 2.70  | 0.091  |       | 0.106 |
| K    | 0.38        |      | 0.55  | 0.015  |       | 0.022 |
| L    | 0           | 0.10 | 0.25  | 0      | 0.004 | 0.010 |
| M    | 1.25        |      | 1.35  | 0.049  |       | 0.053 |

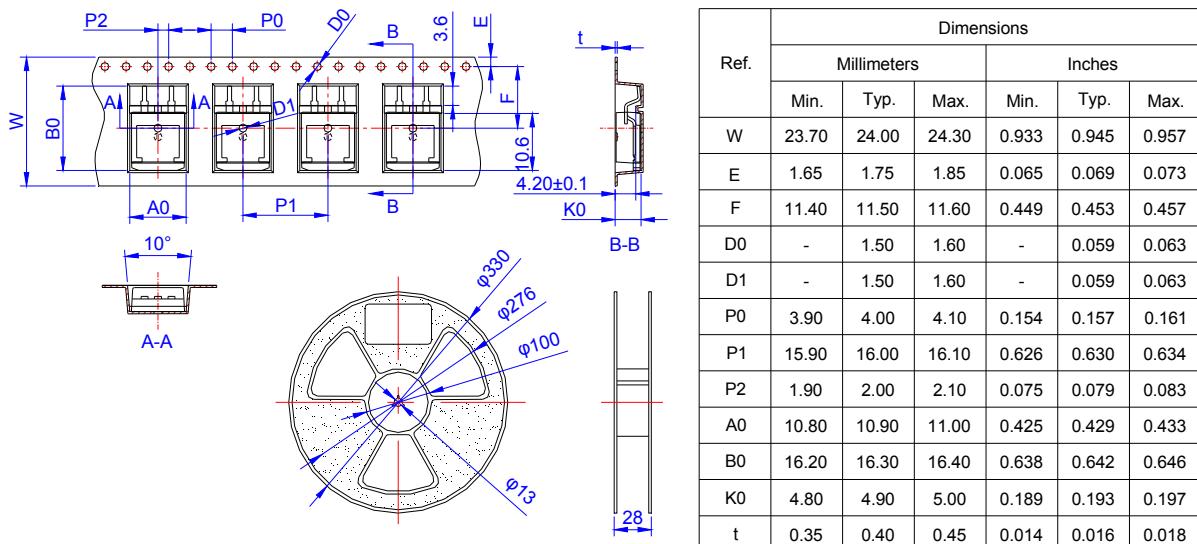
## FOOTPRINT-TO-263 (dimensions in mm)



## DELIVERY MODE



| PACKAGE | OUTLINE | TUBE<br>(PCS) | INNER BOX<br>(PCS) | PER CARTON |
|---------|---------|---------------|--------------------|------------|
| TO-263  | TUBE    | 50            | 1,000              | 5,000      |



| PACKAGE | OUTLINE | REEL<br>(PCS) | PER CARTON<br>(PCS) | TAPE & REEL |
|---------|---------|---------------|---------------------|-------------|
| TO-263  | TAPING  | 800           | 4,000               | 13 inch     |



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